SSC336D/SSC336Q
High-Integrated IP Camera SoC Processor

Preliminary Product Brief Version 0.3

REVISION HISTORY

Revision No.	Description	Date
0.1	• Initial release	10/31/2019
0.2	• Updated Features	01/17/2020
0.3	• Updated Recommended Operating Conditions	02/27/2020

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1. CHIP OVERVIEW

The SSC336D/SSC336Q products are highly integrated multimedia System-on-Chip (SoC) products for high-resolution intelligent video recording applications like IP camera.

The chip includes a 32-bit dual-core RISC processor, advanced Image Signal Processor (ISP), high performance MJPEG/H.264/H.265 video encoder (up to 3M 30fps), Deep Learning Accelerator (DLA), Intelligent Video Engine (IVE), as well as high speed I/O interfaces like MIPI, and Ethernet.

Advanced low-power, low-voltage architecture and optimized design flow are implemented to fulfill long time usage applications. Hardwired AES/DES/3DES cipher engines are integrated to support secure boot, authentication, and video/audio stream encryption in security system.

The SSC336D/SSC336Q, powered by SigmaStar Technology, comes with a complete hardware platform and software SDK, allowing customers to speed up "Time-to-Market."

2. BLOCK DIAGRAM

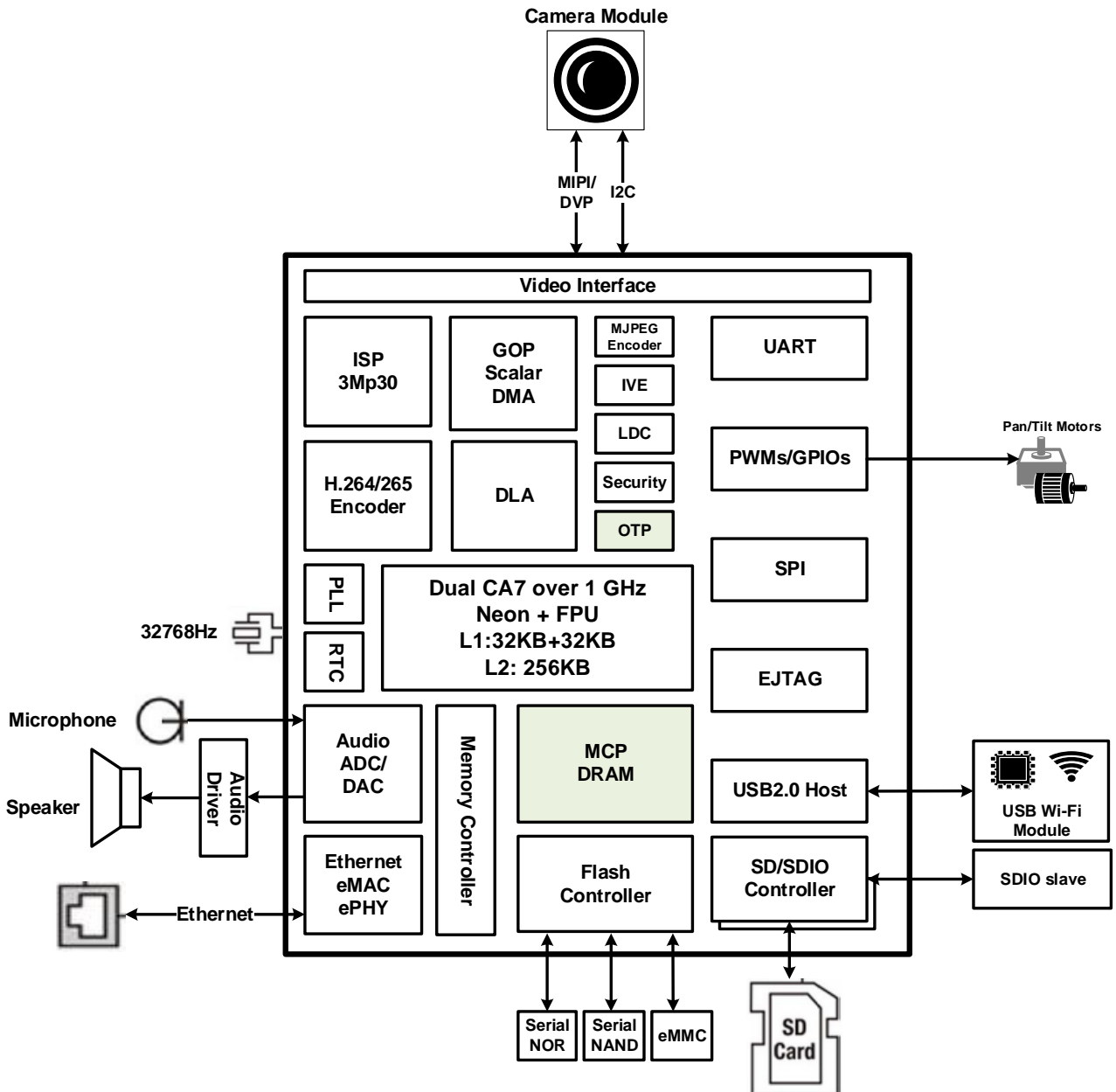Figure 2-1 shows the major functional blocks of SSC336D/SSC336Q series chip.

Figure 2-1: SSC336D/SSC336Q Block Diagram

3. FEATURES

■ **High Performance Processor Core**
- ARM Cortex-A7 Dual Core
- Clock rate over 1GHz
- Neon and FPU
- Memory Management Unit for Linux support
- DMA Engine

■ **Image/Video Processor**
- Supports 8/10/12-bit parallel interface for raw data input
- Supports MIPI interface with 2/4 data lanes and 1 clock lane
- Supports one MIPI interface
- Supports sensor interface with both parallel and MIPI
- Supports 8/10-bit CCIR656 interface
- Supports max. 3M (2304x1296) pixels video recording and image snapshot
- Bad pixel compensation
- Temporal-domain Noise Reduction (3DNR)
- Bayer domain Spatial-domain Noise Reduction (2DNR)
- Bayer domain filter to remove purple false color in highlight regions
- Optical black correction
- Lens shading compensation
- Auto White Balance (AWB) / Auto Exposure (AE) / Auto Focus (AF)
- CFA color interpolation
- Color correction
- Gamma correction
- Video stabilization
- High Dynamic Range (HDR) with two exposure frames and de-ghost function
- Frame buffer data compression and de-compression to save memory bandwidth
- Wide Dynamic Range (WDR) with local tone mapping
- Flip, Mirror, and Rotation with 90 or 270 degree
- Lens distortion correction (LDC/FishEye)
- Rolling shutter compensation
- Fully programmable multi-function scaling engines

■ **Advanced Color Engine**
- Luma gain/offset adjustment
- Supports 2D peaking with user definition filter
- Horizontal noise masking
- Direct Luma Correction (DLC)
- Black/White Level Extension (BLE/WLE)
- IHC/ICC/IBC for chroma adjustment
- Histogram statistics
- Spatial domain IIR filter to reduce noise

■ **H.265/HEVC**
- Supports H.265/HEVC main profile
- Supported Prediction Unit (PU) size: 32x32, 16x16, 8x8
- Supported Transform Unit (TU) size: 32x32 to 4x4
- Search range [H: +/-128, V: +/-64]
- Supports up to quarter-pixel
- Supports frame level and MB level rate control
- Supports ROI encoding with custom QP map
- Supports max. 3M with 30 fps encoding

■ **H.264 Encoder**
- Supports H.264 baseline, constrained baseline, main, and high profile
- Supports 16x16, 8x8 and 4x4 block sizes
- Search range [H: +/-64, V: +/-32]
- Supports up to quarter-pixel
- Supports frame level and MB level rate control
- Supports ROI encoding with custom QP map
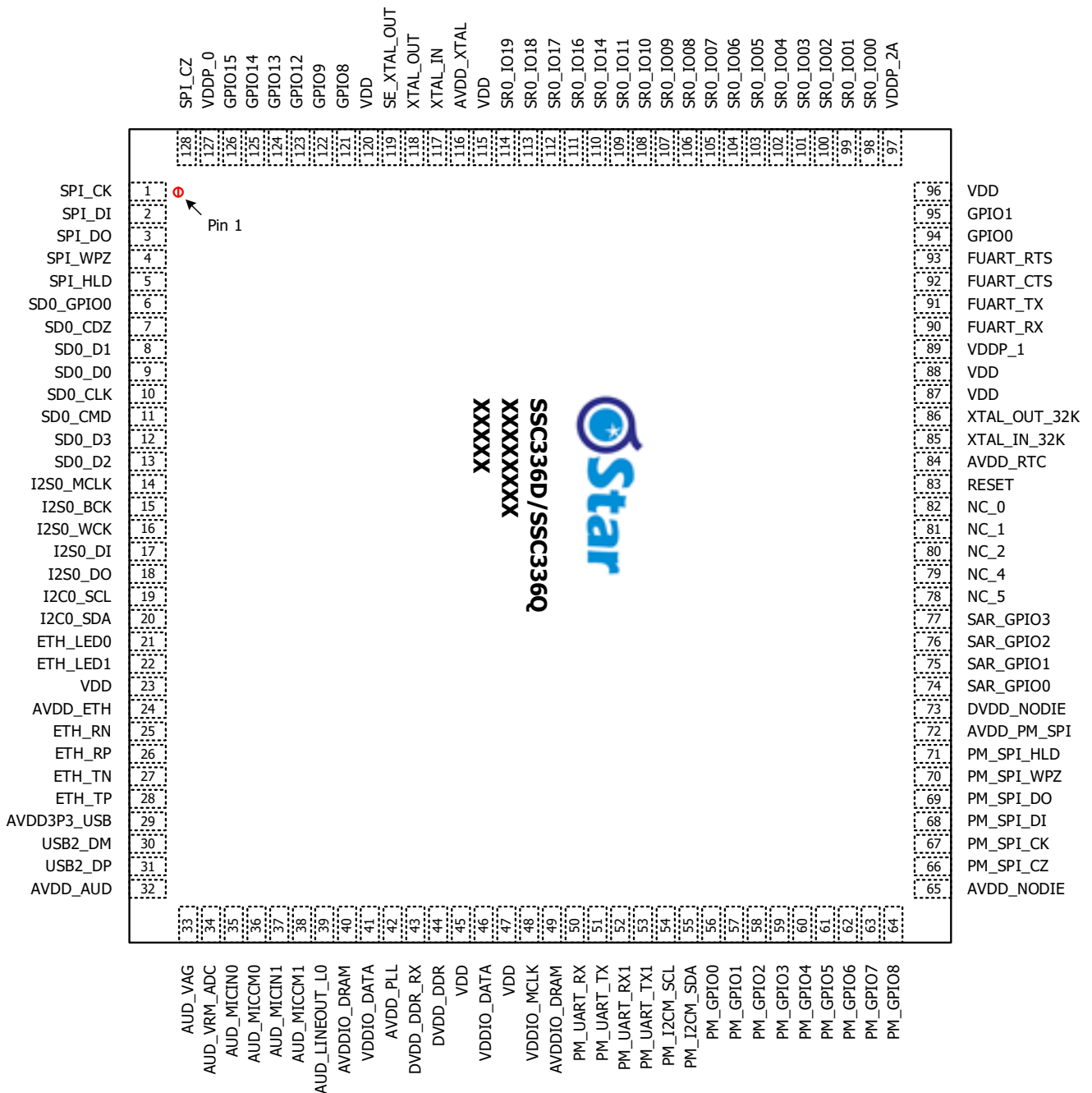- Supports max. 3M with 30 fps encoding

- ■ JPEG Encoder
  - Supports JPEG baseline encoding
  - Supports YUV422 or YUV420 formats
  - Supports max. 3M with 30 fps encoding
  - Supports real-time mode and frame encode mode
- ■ Video Encoding Performance
  - Supports 3M + HD + D1 30fps H.265/HEVC encoding
  - Supports 3M + HD + D1 30fps H.264 encoding
  - Supports MJPEG up to 3M 30 fps encoding
- ■ Deep Learning Accelerator
  - Pure hardwired accelerator
  - Supports various video analysis functions like FD/FR, human detection, MD/OD, object tracking, etc.
- ■ Audio Processor
  - One stereo ADC for microphone input
  - Two stereo DMIC inputs
  - One stereo DAC for lineout
  - Supports 8K/16K/32KHz/48KHz sampling rate audio recording
  - Digital and analog gain adjustment
  - I2S digital audio input and output with TDM up to 8-ch input and 2-ch output
- ■ NOR/NAND Flash Interface
  - Compliant with standard, dual and quad SPI Flash memory components
  - High speed clock/data rate up to 108MHz
- ■ SD Card/eMMC Interface
  - Compatible with SD spec. 2.0, data bus 1/4 bit mode
  - Supports eMMC 4.3 interface
- ■ SDIO 2.0 Interface
  - Compatible with SDIO spec. 2.0, data bus 1/4 bit mode
  - Compatible with SD spec. 2.0, data bus 1/4 bit mode
- ■ USB Interface
  - One USB 2.0 configurable host or device
    - Host mode supports EHCI specification
    - Device mode supports 4 endpoints
  - Supports suspend/hibernation/wake-up power saving mode

- ■ DRAM Memory
  - Embedded 1Gb or 2Gb 16-bit DDR3 memory with max. 2133Mbps
- ■ Connectivity
  - Built-in 10/100M Ethernet MAC and Ethernet PHY
  - USB 2.0 Host Controller could be used for USB Wi-Fi Dongle or Module
  - SDIO 2.0 Host Controller could be used for SDIO Wi-Fi module
  - Supports Wake-on-LAN (WOL)
- ■ Security Engines
  - Supports AES/DES/3DES/RSA/SHA-I/SHA-256
  - Supports secure booting
- ■ Real Time Clock (RTC)
  - Built-in RTC working with 32.768 KHz crystal
  - Alarm interrupt for wakeup
  - Tick time interrupt (millisecond)
  - Built-in regulator
  - Supports low leakage RTC-mode for long battery application
- ■ Peripherals
  - Dedicated GPIOs for system control
  - Supports max. 11 PWM outputs
  - Three generic UARTs and one fast UART with flow control
  - Three generic timers and one watchdog timer
  - Two SPI masters
  - Four I2C Masters
  - Built-in SAR ADC with 4-channel analog inputs for different kinds of applications
  - Supports internal temperature sensor
- ■ Operating Voltage Range
  - Core: 0.9V
  - I/O: 1.8 ~ 3.3V
  - DRAM: 1.5V (DDR3) or 1.35V (DDR3L)
  - Power Consumption: TBD
- ■ Package
  - QFN with 128 pins, 12.3mm x 12.3mm

4. PACKAGE DESCRIPTION

4.1. Pin Diagram

Top pins (left to right): SPI_CZ (128), VDDP_0 (127), GPIO15 (126), GPIO14 (125), GPIO13 (124), GPIO12 (123), GPIO9 (122), GPIO8 (121), VDD (120), SE_XTAL_OUT (119), XTAL_OUT (118), XTAL_IN (117), AVDD_XTAL (116), VDD (115), SR0_IO19 (114), SR0_IO18 (113), SR0_IO17 (112), SR0_IO16 (111), SR0_IO14 (110), SR0_IO11 (109), SR0_IO10 (108), SR0_IO09 (107), SR0_IO08 (106), SR0_IO07 (105), SR0_IO06 (104), SR0_IO05 (103), SR0_IO04 (102), SR0_IO03 (101), SR0_IO02 (100), SR0_IO01 (99), SR0_IO00 (98), VDDP_2A (97)

Left pins (top to bottom):
1 SPI_CK
2 SPI_DI
3 SPI_DO
4 SPI_WPZ
5 SPI_HLD
6 SD0_GPIO0
7 SD0_CDZ
8 SD0_D1
9 SD0_D0
10 SD0_CLK
11 SD0_CMD
12 SD0_D3
13 SD0_D2
14 I2S0_MCLK
15 I2S0_BCK
16 I2S0_WCK
17 I2S0_DI
18 I2S0_DO
19 I2C0_SCL
20 I2C0_SDA
21 ETH_LED0
22 ETH_LED1
23 VDD
24 AVDD_ETH
25 ETH_RN
26 ETH_RP
27 ETH_TN
28 ETH_TP
29 AVDD3P3_USB
30 USB2_DM
31 USB2_DP
32 AVDD_AUD

Pin 1

SSC336D/SSC336Q
XXXXX
XXXXXX
XXXXX

Right pins (top to bottom):
96 VDD
95 GPIO1
94 GPIO0
93 FUART_RTS
92 FUART_CTS
91 FUART_TX
90 FUART_RX
89 VDDP_1
88 VDD
87 VDD
86 XTAL_OUT_32K
85 XTAL_IN_32K
84 AVDD_RTC
83 RESET
82 NC_0
81 NC_1
80 NC_2
79 NC_4
78 NC_5
77 SAR_GPIO3
76 SAR_GPIO2
75 SAR_GPIO1
74 SAR_GPIO0
73 DVDD_NODIE
72 AVDD_PM_SPI
71 PM_SPI_HLD
70 PM_SPI_WPZ
69 PM_SPI_DO
68 PM_SPI_DI
67 PM_SPI_CK
66 PM_SPI_CZ
65 AVDD_NODIE

Bottom pins (left to right):
33 AUD_VAG
34 AUD_VRM_ADC
35 AUD_MICIN0
36 AUD_MICCM0
37 AUD_MICIN1
38 AUD_MICCM1
39 AUD_LINEOUT_L0
40 AVDDIO_DRAM
41 VDDIO_DATA
42 AVDD_PLL
43 DVDD_DDR_RX
44 DVDD_DDR
45 VDD
46 VDDIO_DATA
47 VDD
48 VDDIO_MCLK
49 AVDDIO_DRAM
50 PM_UART_RX
51 PM_UART_TX
52 PM_UART_RX1
53 PM_UART_TX1
54 PM_I2CM_SCL
55 PM_I2CM_SDA
56 PM_GPIO0
57 PM_GPIO1
58 PM_GPIO2
59 PM_GPIO3
60 PM_GPIO4
61 PM_GPIO5
62 PM_GPIO6
63 PM_GPIO7
64 PM_GPIO8

4.2. Signal Description

Signal Name	Signal Type	Function	QFN128 Pin Location
System Reset Interface			
RESET	I	System Reset (Active High)	83
Debug UART Interface			
PM_UART_RX	I	Debug UART Receive Data Input with Pull Up Resistor / Slave I2C Serial Clock	50
PM_UART_TX	O	Debug UART Transmit Data Output with Pull Up Resistor / Slave I2C Serial Data	51
PM_UART_RX1	I	PM_UART1 Receive Data Input with Pull Up Resistor in Power Manage group domain	52
PM_UART_TX1	O	PM_UART1 Transmit Data Output with Pull Up Resistor in Power Manage group domain	53
System Interface			
XTAL_IN	I	24MHz Crystal Input	117
XTAL_OUT	O	24MHz Crystal Output	118
XTAL_IN_32K	I	32.768KHz Crystal Input	85
XTAL_OUT_32K	O	32.768KHz Crystal Output	86
SE_XTAL_OUT	O	24MHz Clock Output	119
8051 SPI Flash Interface			
PM_SPI_CZ	O	SPI Flash Chip Select (Active Low)	66
PM_SPI_CK	O	SPI Flash Clock	67
PM_SPI_DI	O	SPI Flash Serial Data To Device (MOSI)	68
PM_SPI_DO	I	SPI Flash Serial Data From Device (MISO)	69
PM_SPI_WPZ	O	SPI Flash Write Protect	70
PM_SPI_HLD	O	SPI Flash Hold	71
GPIO Interface			
GPIO0	I/O	General Purpose Input/Output 0	94
GPIO1	I/O	General Purpose Input/Output 1	95
GPIO8	I/O	General Purpose Input/Output 8	121
GPIO9	I/O	General Purpose Input/Output 9	122
GPIO12	I/O	General Purpose Input/Output 12	123

| Signal Name	Signal Type	Function	QFN128 Pin Location
GPIO13	I/O	General Purpose Input/Output 13	124
GPIO14	I/O	General Purpose Input/Output 14	125
GPIO15	I/O	General Purpose Input/Output 15	126
PM GPIO Interface			
PM_GPIO0	I/O	Power Manage Group General Purpose Input/Output 0	56
PM_GPIO1	I/O	Power Manage Group General Purpose Input/Output 1	57
PM_GPIO2	I/O	Power Manage Group General Purpose Input/Output 2	58
PM_GPIO3	I/O	Power Manage Group General Purpose Input/Output 3	59
PM_GPIO4	I/O	Power Manage Group General Purpose Input/Output 4	60
PM_GPIO5	I/O	Power Manage Group General Purpose Input/Output 5	61
PM_GPIO6	I/O	Power Manage Group General Purpose Input/Output 6	62
PM_GPIO7	I/O	Power Manage Group General Purpose Input/Output 7	63
PM_GPIO8	I/O	Power Manage Group General Purpose Input/Output 8	64
SAR ADC Interface			
SAR_GPIO0	I	General Purpose Input/Output or Muxed to SARADC Input Channel 0	74
SAR_GPIO1	I	General Purpose Input/Output or Muxed to SARADC Input Channel 1	75
SAR_GPIO2	I	General Purpose Input/Output or Muxed to SARADC Input Channel 2	76
SAR_GPIO3	I	General Purpose Input/Output or Muxed to SARADC Input Channel 3	77
CA7 SPI Flash Interface			
SPI_CZ	O	Master SPI Chip Select (Active Low)	128
SPI_CK	O	Master SPI Serial Clock	1
SPI_DI	I/O	Master SPI Serial Data To Device (MOSI) / SDIO0 - 4x IO mode	2
SPI_DO	I/O	Master SPI Serial Data From Device (MISO) / SDIO1 - 4x IO mode	3
SPI_WPZ	I/O	Master SPI Write Protect (Active Low) / SDIO2 - 4x IO mode	4

Signal Name	Signal Type	Function	QFN128 Pin Location
SPI_HLD	I/O	Master SPI Hold input (Active Low) / SDIO3 - 4x IO mode	5
I2S Interface			
I2S0_MCLK	O	I2S Master Clock	14
I2S0_BCK	O	I2S Bit Clock	15
I2S0_WCK	O	I2S Word Clock	16
I2S0_DI	I	I2S Data Input	17
I2S0_DO	O	I2S Data Output	18
Master I2C Interface			
I2C0_SCL	O	Non-PM Domain I2C 0 Master I2C Clock	19
I2C0_SDA	I	Non-PM Domain I2C 0 Master I2C Data	20
PM_I2CM_SCL	O	PM Domain I2C Master I2C Clock	54
PM_I2CM_SDA	I	PM Domain I2C Master I2C Data	55
Fast UART Interface			
FUART_RX	I	Fast UART Receive Data Input	90
FUART_TX	O	Fast UART Transmit Data Output	91
FUART_CTS	I	Fast UART Clear to Send	92
FUART_RTS	O	Fast UART Request to Send	93
Image Sensor Interface			
SR0_IO00	I/O	Sensor General Purpose Input/Output 0	98
SR0_IO01	I/O	Sensor General Purpose Input/Output 1	99
SR0_IO02	I/O	Sensor General Purpose Input/Output 2	100
SR0_IO03	I/O	Sensor General Purpose Input/Output 3	101
SR0_IO04	I/O	Sensor General Purpose Input/Output 4	102
SR0_IO05	I/O	Sensor General Purpose Input/Output 5	103
SR0_IO06	I/O	Sensor General Purpose Input/Output 6	104
SR0_IO07	I/O	Sensor General Purpose Input/Output 7	105
SR0_IO08	I/O	Sensor General Purpose Input/Output 8	106
SR0_IO09	I/O	Sensor General Purpose Input/Output 9	107
SR0_IO10	I/O	Sensor General Purpose Input/Output 10	108
SR0_IO11	I/O	Sensor General Purpose Input/Output 11	109

Signal Name	Signal Type	Function	QFN128 Pin Location
SR0_IO14	I/O	Sensor General Purpose Input/Output 14	110
SR0_IO16	I/O	Sensor General Purpose Input/Output 16	111
SR0_IO17	I/O	Sensor General Purpose Input/Output 17	112
SR0_IO18	I/O	Sensor General Purpose Input/Output 18	113
SR0_IO19	I/O	Sensor General Purpose Input/Output 19	114
10/100M Ethernet Interface			
ETH_RN	I	10/100M Ethernet Differential Pair of Receiver Signal Negative	25
ETH_RP	I	10/100M Ethernet Differential Pair of Receiver Signal Positive	26
ETH_TN	O	10/100M Ethernet Differential Pair of Transmitter Signal Negative	27
ETH_TP	O	10/100M Ethernet Differential Pair of Transmitter Signal Positive	28
ETH_LED0	O	10/100M Ethernet LED0 Control Driven Active When Linked	21
ETH_LED1	O	10/100M Ethernet LED1 Control Driven Active When Linked in 100 Base-TX and Blinking When Transmitting or Receiving Data	22
SD 2.0 Card Interface			
SD0_CLK	O	SD 2.0 Clock	10
SD0_CMD	O	SD 2.0 Command	11
SD0_D0	I/O	SD 2.0 Data Bus 0	9
SD0_D1	I/O	SD 2.0 Data Bus 1	8
SD0_D2	I/O	SD 2.0 Data Bus 2	13
SD0_D3	I/O	SD 2.0 Data Bus 3	12
SD0_CDZ	I	Power Manage SD 2.0 Card Detect	7
SD0_GPIO0	I/O	SD0 General Purpose Input/Output 0	6
Audio Line Out Interface			
AUD_LINEOUT_L0	O	Audio Left Channel Line Output	39
AUD_VAG	O	Audio Reference Voltage from 1/2 AVDD_AUD	33
AUD_VRM_ADC	I	Audio Reference Voltage for ADC	34
Analog Microphone Interface			
AUD_MICIN0	I	Audio Left Channel Microphone Positive Input	35
AUD_MICCM0	I	Audio Left Channel Microphone Negative Input	36

Signal Name	Signal Type	Function	QFN128 Pin Location
AUD_MICIN1	I	Audio Right Channel Microphone Positive Input	37
AUD_MICCM1	I	Audio Right Channel Microphone Negative Input	38
USB 2.0 Interface			
USB2_DM	I/O	USB 2.0 Differential Pair, Negative	30
USB2_DP	I/O	USB 2.0 Differential Pair, Positive	31
Test Interface			
NC_0	I/O	RTC Test Pin (NC)	82
NC_1	I/O	RTC Test Pin (NC)	81
NC_2	I/O	RTC Test Pin (NC)	80
NC_4	I/O	RTC Test Pin (NC)	79
NC_5	I/O	RTC Test Pin (NC)	78
Power pins			
VDD	Core Power	Digital Core Power	23, 45, 47, 87, 88, 96, 115, 120
VDDP_0	3.3V Power	Digital Input/Output Power for Domain 0	127
VDDP_1	3.3V Power	Digital Input/Output Power for Domain 1	89
VDDP_2A	3.3V Power	Digital Input/Output Power for Domain 2A (Sensor IO Group 0 Power)	97
DVDD_DDR_RX	Core Power	Digital Power for DDR RX LDO (0.1uF CAP to GND)	43
DVDD_DDR	Core Power	Digital Power for DDR TX	44
VDDIO_DATA	DDR Power	IO Power for DDR Data	41, 46
VDDIO_MCLK	DDR Power	IO Power for DDR Clock	48
AVDDIO_DRAM	DDR Power	IO Power for embedded DRAM	40, 49
AVDD_NODIE	3.3V Power	Analog Power for PM Domain	65
DVDD_NODIE	O	PM Domain LDO Output (1uF Cap to GND)	73
AVDD_PM_SPI	3.3V Power	Analog Power for PM SPI Domain	72
AVDD_PLL	3.3V Power	Analog Power for PLL	42
AVDD_XTAL	3.3V Power	Analog Power for XTAL	116
AVDD_RTC	3.3V Power	Analog Power for RTC	84
AVDD3P3_USB	3.3V Power	Analog Power for USB2.0	29
AVDD_ETH	3.3V Power	Analog Power for Ethernet	24

Signal Name	Signal Type	Function	QFN128 Pin Location
AVDD_AUD	3.3V Power	Analog Power for Audio	32
GND	GND	Ground	ePad

4.3. Mechanical Dimensions

Top View

Side View

Bottom View
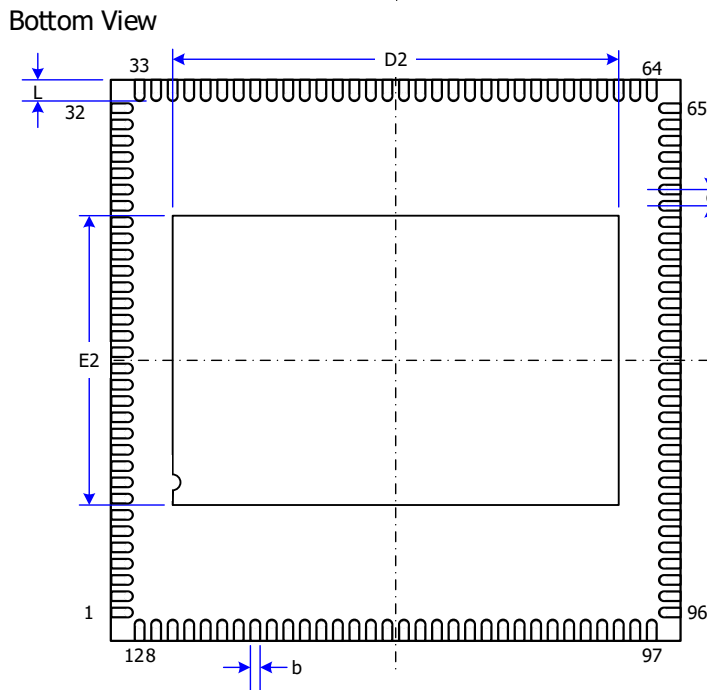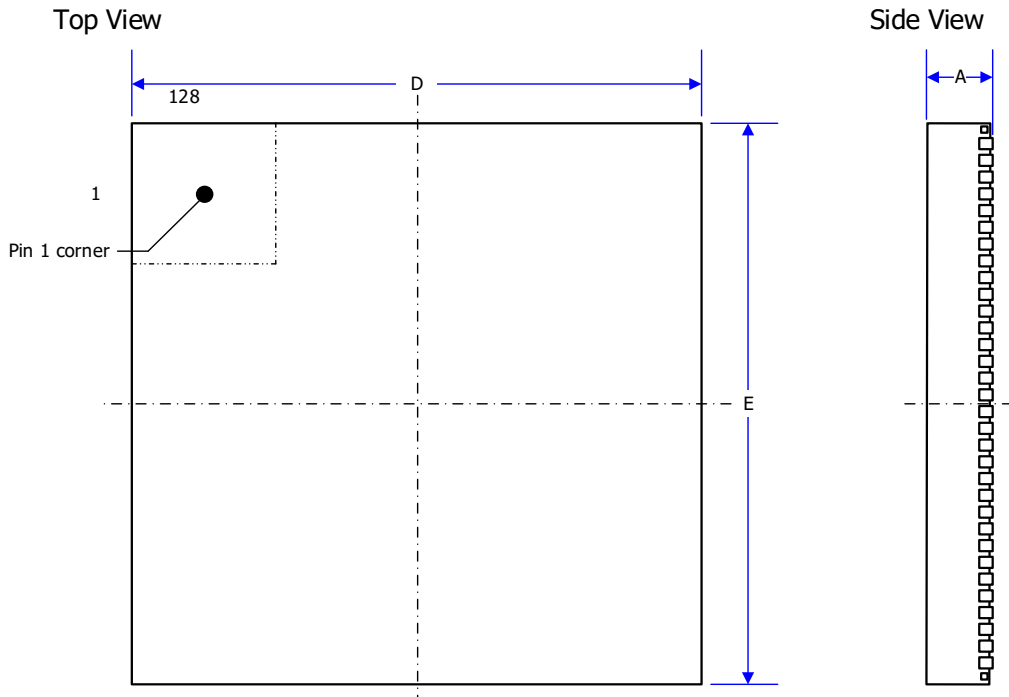
Symbol	Millimeter			Inch		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.80	0.85	0.90	0.031	0.033	0.035
D	12.20	12.30	12.40	0.480	0.484	0.488
E	12.20	12.30	12.40	0.480	0.484	0.488
D2	9.40	9.50	9.60	0.370	0.374	0.378
E2	6.10	6.20	6.30	0.240	0.244	0.248
b	0.10	0.15	0.20	0.004	0.006	0.008
e	--	0.35	--	--	0.014	--
L	0.30	0.40	0.50	0.012	0.016	0.020

Note: E-pad has to connect to system GND net.

5. ELECTRICAL CHARACTERISTIC

5.1. Absolute Maximum Ratings

Parameter	Symbol	Min	Typ.	Max.	Unit
Core Power Supply Voltage	VDD	-0.3		1.26	V
3.3V I/O Supply Voltage	VDDP_0 VDDP_1	-0.3		3.63	V
1.8~3.3V I/O Supply Voltage	VDDP_2A VDDP_2B AVDD_PM_SPI	-0.3		3.63	V
DDR Digital Power Supply Voltage	DVDD_DDR*	-0.3		1.26	V
DDR IO Power Supply Voltage (DDR3/L)	VDDIO_* AVDD*_DRAM	-0.3		1.8	V
PM IO Power Supply Voltage	AVDD_NODIE	-0.3		3.63	V
3.3V Analog Power Supply Voltage	AVDD*	-0.3		3.63	V
0.9V Analog Power Supply Voltage	AVDDL*	-0.3		1.26	V
Storage Temperature	T_{STG}	-40		150	°C

Note: Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and does not imply functional operation of device. Exposure to absolute maximum ratings for extended periods may affect device reliability.

5.2. Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max	Unit
VDD	Digital Core Power	0.825	0.9	1.05	V
VDDP_0	Digital Input/Output Power for Domain 0	2.97	3.3	3.63	V
VDDP_1	Digital Input/Output Power for Domain 1	2.97	3.3	3.63	V
	Digital Input/Output Power for Domain 1	1.62	1.8	1.98	V
VDDP_2A	Digital Input/Output Power for Domain 2A (Sensor IO Group 0 Power)	2.97	3.3	3.63	V
	Digital Input/Output Power for Domain 2A (Sensor IO Group 0 Power)	1.62	1.8	1.98	V
DVDD_DDR_RX	Digital Power for DDR RX LDO (0.1uF CAP to GND)	TBD	0.9	TBD	V
DVDD_DDR	Digital Power for DDR TX	TBD	0.9	TBD	V
VDDIO_DATA	(DDR3) IO Power for DDR Data	1.45	1.5	1.55	V
VDDIO_MCLK	(DDR3) IO Power for DDR Clock	1.45	1.5	1.55	V
AVDDIO_DRAM	(DDR3) IO Power for embedded DRAM	1.45	1.5	1.55	V
AVDD_NODIE	Analog Power for PM Domain	2.97	3.3	3.63	V
DVDD_NODIE	PM Domain LDO Output (1uF Cap to GND)	TBD	0.9	TBD	V
AVDD_PM_SPI	External power supply for 3.3V IO	2.97	3.3	3.63	V
AVDD_PLL	Analog Power for PLL	3.14	3.3	3.46	V
AVDD_XTAL	Analog Power for XTAL	3.14	3.3	3.46	V
AVDD_RTC	Analog Power for RTC	1.6	3	3.6	V
AVDD3P3_USB	Analog Power for USB2.0	3.14	3.3	3.46	V
AVDD_ETH	Analog Power for Ethernet	3.14	3.3	3.46	V
AVDD_AUD	Analog Power for Audio	3.14	3.3	3.46	V
Junction Temperature				125	°C

6. ORDERING GUIDE

Part Number	Temperature Range	Package Description	Package Option
SSC336D/SSC336Q	-20°C to +60°C	QFN	128

6.1. Marking Information

SSC336D/SSC336Q

Part Number
Lot Number
Operation Code A
Operation Code B
Date Code (YYWW)
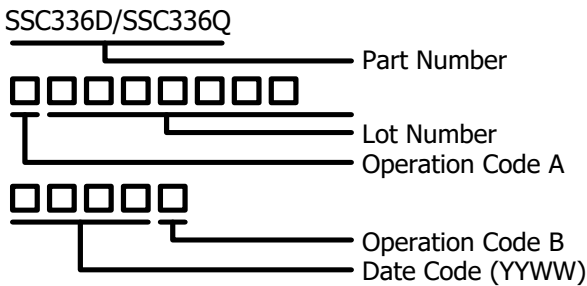
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Electrostatic charges accumulate on both test equipment and human body and can discharge without detection. SSC336D/SSC336Q comes with ESD protection circuitry; however, the device may be permanently damaged when subjected to high energy discharges. The device should be handled with proper ESD precautions to prevent malfunction and performance degradation.